

P_D	200	mW
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● Feature

High reliability
Small mold type

● Application

Voltage regulation

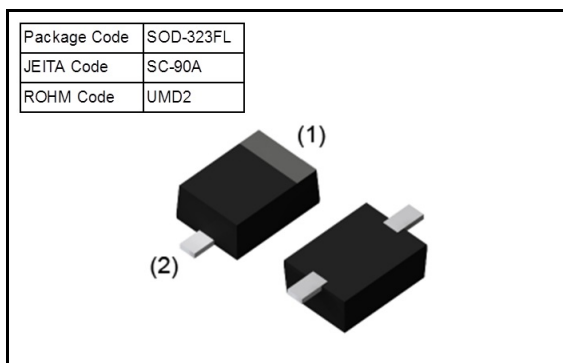
● Structure

Silicon Epitaxial Planar

● Absolute Maximum Rating ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Limits	Unit
Power dissipation	P_D	200	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 ~ 150	$^\circ\text{C}$

● Outline



● Inner Circuit



● Packaging Specification

Packing	Embossed Tape
Reel Size(mm)	180
Taping Width(mm)	8
Basic Ordering Unit(pcs)	3000
Taping Code	TE-17
Marking	A5

● Characteristic ($T_a = 25^\circ\text{C}$)

P/N	Symbol								
	Zener Voltage: $V_Z(\text{V})$			Dynamic Impedance: $Z_Z(\Omega)$		Zener Impedance: $Z_{ZK}(\Omega)$		Reverse Current: $I_R(\mu\text{A})$	
	MIN.	MAX.	$I_Z(\text{mA})$	MAX.	$I_Z(\text{mA})$	MAX.	$I_Z(\text{mA})$	MAX.	$V_R(\text{V})$
UDZV 2.0B	2.020	2.200	5	100	5	1000	0.5	120	0.5
UDZV 2.2B	2.220	2.410	5	100	5	1000	0.5	120	0.7
UDZV 2.4B	2.430	2.630	5	100	5	1000	0.5	120	1.0
UDZV 2.7B	2.690	2.910	5	110	5	1000	0.5	100	1.0
UDZV 3.0B	3.010	3.220	5	120	5	1000	0.5	50	1.0
UDZV 3.3B	3.320	3.530	5	120	5	1000	0.5	20	1.0
UDZV 3.6B	3.600	3.845	5	100	5	1000	1.0	10	1.0
UDZV 3.9B	3.890	4.160	5	100	5	1000	1.0	5	1.0
UDZV 4.3B	4.170	4.430	5	100	5	1000	1.0	5	1.0
UDZV 4.7B	4.550	4.750	5	100	5	800	0.5	2	1.0
UDZV 5.1B	4.980	5.200	5	80	5	500	0.5	2	1.5
UDZV 5.6B	5.490	5.730	5	60	5	200	0.5	1	2.5
UDZV 6.2B	6.060	6.330	5	60	5	100	0.5	1	3.0
UDZV 6.8B	6.650	6.930	5	40	5	60	0.5	0.5	3.5
UDZV 7.5B	7.280	7.600	5	30	5	60	0.5	0.5	4.0
UDZV 8.2B	8.020	8.360	5	30	5	60	0.5	0.5	5.0
UDZV 9.1B	8.850	9.230	5	30	5	60	0.5	0.5	6.0
UDZV 10B	9.770	10.210	5	30	5	60	0.5	0.1	7.0
UDZV 11B	10.760	11.220	5	30	5	60	0.5	0.1	8.0
UDZV 12B	11.740	12.240	5	30	5	80	0.5	0.1	9.0
UDZV 13B	12.910	13.490	5	37	5	80	0.5	0.1	10.0
UDZV 15B	14.340	14.980	5	42	5	80	0.5	0.1	11.0
UDZV 16B	15.850	16.510	5	50	5	80	0.5	0.1	12.0
UDZV 18B	17.560	18.350	5	65	5	80	0.5	0.1	13.0
UDZV 20B	19.520	20.390	5	85	5	100	0.5	0.1	15.0
UDZV 22B	21.540	22.470	5	100	5	100	0.5	0.1	17.0
UDZV 24B	23.720	24.780	5	120	5	120	0.5	0.1	19.0
UDZV 27B	26.190	27.530	5	150	5	150	0.5	0.1	21.0
UDZV 30B	29.190	30.690	5	200	5	200	0.5	0.1	23.0
UDZV 33B	32.150	33.790	5	250	5	250	0.5	0.1	25.0
UDZV 36B	35.070	36.870	5	300	5	300	0.5	0.1	27.0
UDZV 39B	38.020	39.980	2	300	2	-	-	0.1	30.0
UDZV 43	40.000	45.000	2	550	2	-	-	0.1	33.0
UDZV 47	44.000	49.000	2	600	2	-	-	0.1	36.0

 V_Z test time is 40ms.

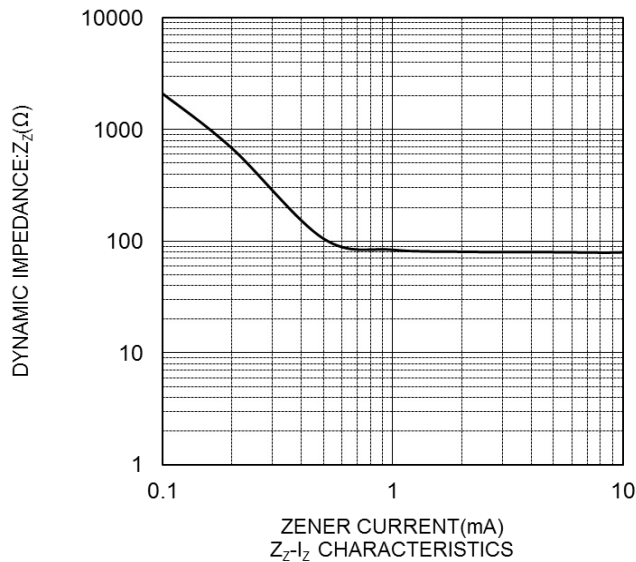
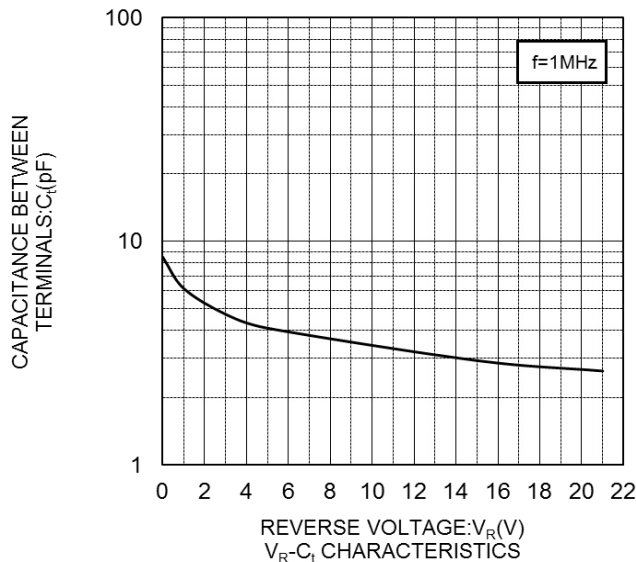
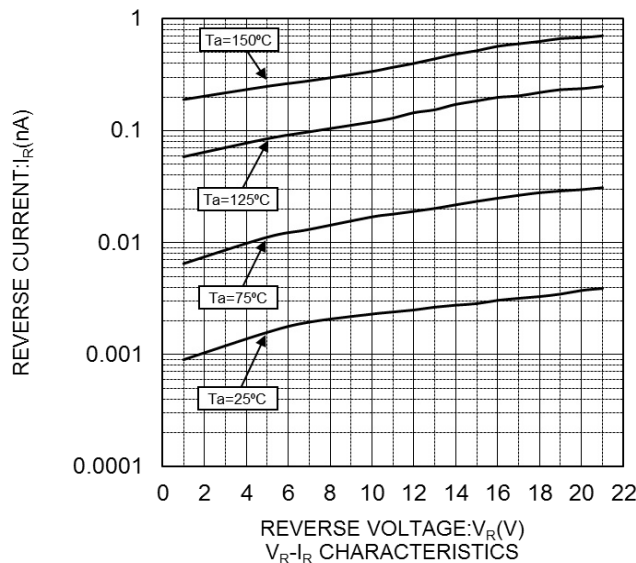
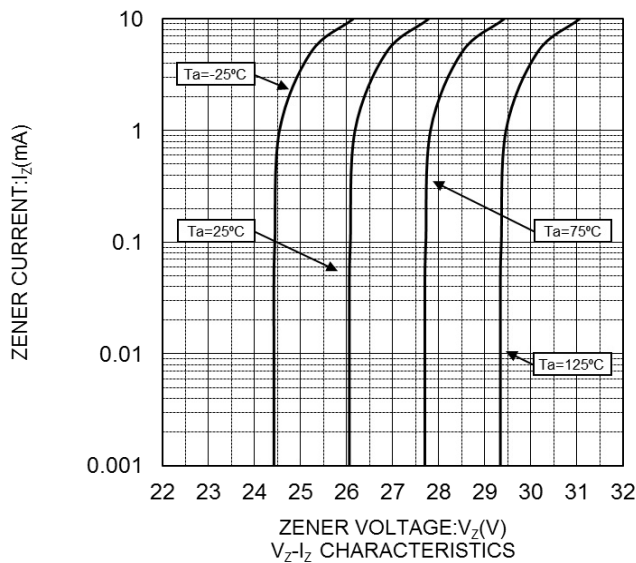
● Marking

P/N	Marking	P/N	Marking
UDZV 2.0B	02	UDZV 10B	05
UDZV 2.2B	12	UDZV 11B	15
UDZV 2.4B	22	UDZV 12B	25
UDZV 2.7B	32	UDZV 13B	35
UDZV 3.0B	42	UDZV 15B	45
UDZV 3.3B	52	UDZV 16B	55
UDZV 3.6B	62	UDZV 18B	65
UDZV 3.9B	72	UDZV 20B	75
UDZV 4.3B	82	UDZV 22B	85
UDZV 4.7B	92	UDZV 24B	95
UDZV 5.1B	A2	UDZV 27B	A5
UDZV 5.6B	C2	UDZV 30B	C5
UDZV 6.2B	E2	UDZV 33B	E5
UDZV 6.8B	F2	UDZV 36B	F5
UDZV 7.5B	H2	UDZV 39B	H5
UDZV 8.2B	J2	UDZV 43	L8
UDZV 9.1B	L2	UDZV 47	M8

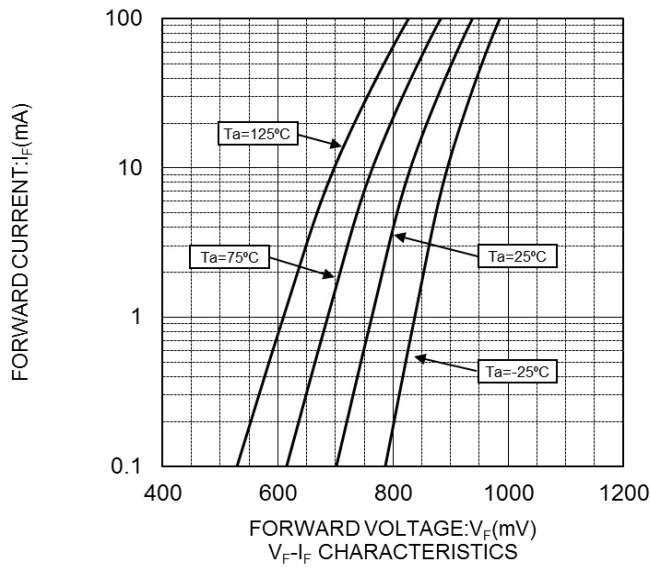
● Characteristic Curves



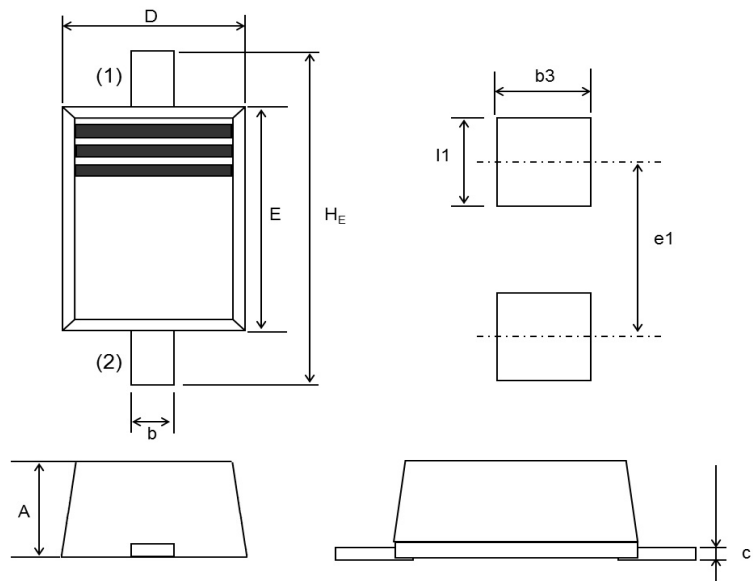
● Characteristic Curves



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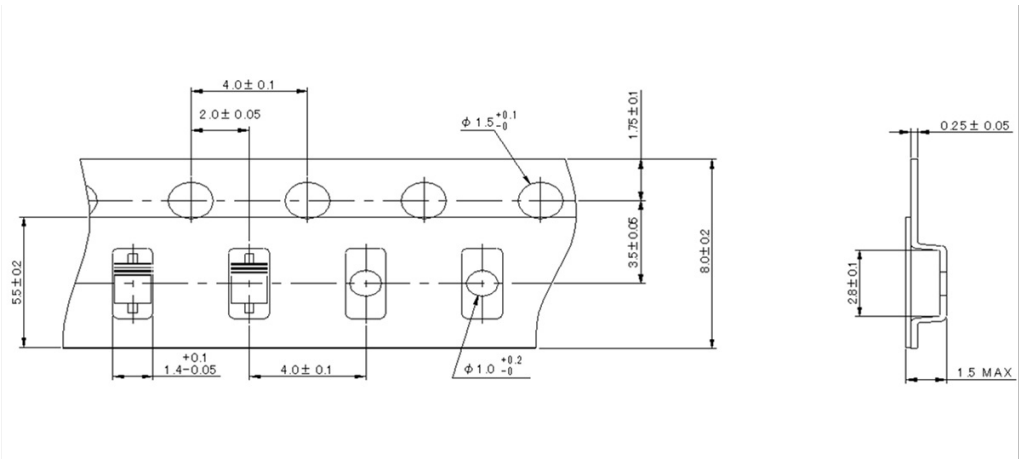
● Dimension (UMD2 SOD-323F SC-90A)



DIM	Millimeters			Inches		
	Min.	Average	Max.	Min.	Average	Max.
A	0.60	0.70	0.90	0.024	0.028	0.035
b	0.25	0.30	0.35	0.010	0.012	0.014
c	0.05	0.10	0.20	0.002	0.004	0.008
D	1.15	1.25	1.35	0.045	0.049	0.053
E	1.60	1.70	1.80	0.063	0.067	0.071
H _E	2.30	2.50	2.70	0.091	0.098	0.106
l1	0.80	-	-	0.031	-	-
b3	0.90	-	-	0.035	-	-
e1	-	2.10	-	-	0.083	-

(1) The marking bar indicates the cathode.
(2) The direction indicates the anode.

● Taping (Unit:mm)



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Precaution for Disposition

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